

# Model RFP-050100-1X50-2

# Chip Terminations 5 Watts, 50 Ω

# RF Power

### **Features**

- DC 6.0 GHz
- 5 Watts
- BeO Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested

### **General Specifications**

Resistive Element: Thick film

Substrate: Beryllium oxide ceramic

**Terminals:** Thick film silver

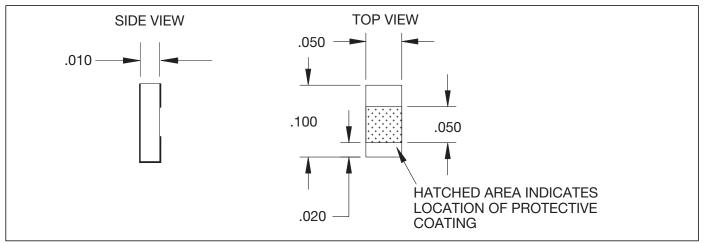
### **Electrical Specifications**

Resistance Value:50 ohms,  $\pm 2\%$ Frequency Range:DC - 6.0 GHzPower:5 WattsV.S.W.R.:1.25:1

**Notes:** Tolerance is  $\pm .010$ , unless otherwise specified. Operating temperature is -55°C to +150°C (see chart). Designed to meet or exceed applicable portions of MIL-E-5400. All dimensions are in inches.

Specifications subject to change without notice.

### **Outline Drawing**



VER. 12/5/01

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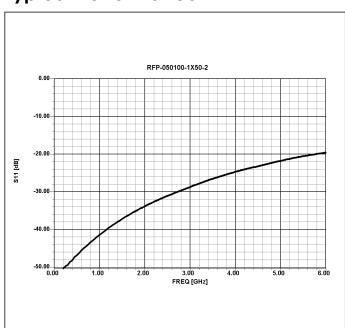


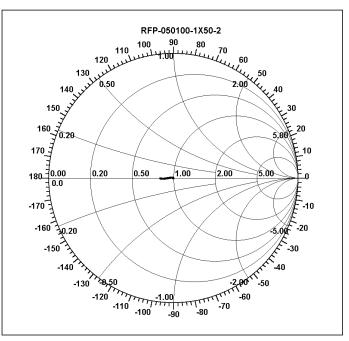
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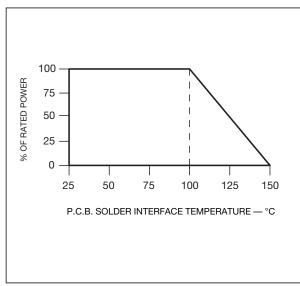


### **Typical Performance**

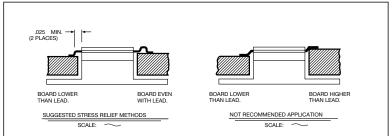




### **Power Derating**



### **Suggested Mounting Procedures**



- 1. Make sure that the devices are mounted on flat surfaces (.001" under the device) to optimize the heat transfer.
- 2. Position device on mounting surface and solder in place using an indalloy type or a 60/40 type solder.
- 3. Solder leads in place using a 60/40 type solder with a controlled temperature iron (700°F).



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